

# MOS FIELD EFFECT TRANSISTOR 2SK2363/2SK2364

# SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

#### **DESCRIPTION**

The 2SK2363/2SK2364 is N-Channel MOS Field Effect Transistor designed for high voltage switching applications.

#### **FEATURES**

· Low On-Resistance

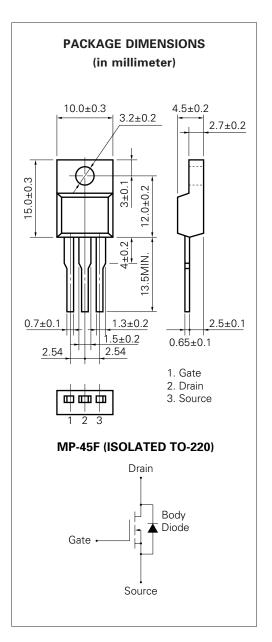
2SK2363: RDS (on) = 0.5  $\Omega$  (VGS = 10 V, ID = 4.0 A) 2SK2364: RDS (on) = 0.6  $\Omega$  (VGS = 10 V, ID = 4.0 A)

- Low Ciss Ciss = 1600 pF TYP.
- · High Avalanche Capability Ratings
- Isolate TO-220 Package

#### ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Drain to Source Voltage (2SK2363/2SK2364)	VDSS	450/500	V
Gate to Source Voltage	Vgss	±30	V
Drain Current (DC)	Id(DC)	±8.0	Α
Drain Current (pulse)*	I <sub>D(pulse</sub>	±32	Α
Total Power Dissipation ( $T_c = 25$ °C)	P <sub>T1</sub>	35	W
Total Power Dissipation (T <sub>A</sub> = 25 °C)	$P_{T2}$	2.0	W
Channel Temperature	$T_ch$	150	°C
Storage Temperature	T <sub>stg</sub> -	–55 to +150	°C
Single Avalanche Current**	las	8.0	Α
Single Avalanche Energy**	Eas	320	mJ

- \* PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1 %
- \*\* Starting Tch = 25 °C, Rg = 25  $\Omega$ , Vgs = 20 V  $\rightarrow$  0



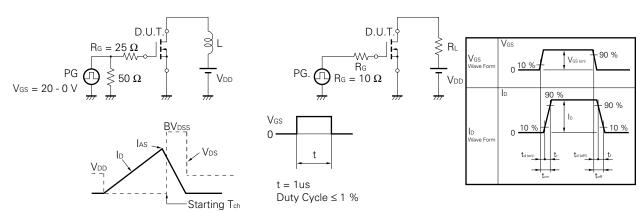


# **ELECTRICAL CHARACTERISTICS (TA = 25 °C)**

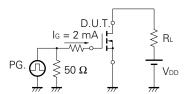
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS	
Drain to Source On-Resistance	RDS (on)		0.4	0.5	Ω	Vgs = 10 V	2SK2363
			0.5	0.6	Ω	ID = 4.0 A	2SK2364
Gate to Source Cutoff Voltage	VGS (off)	2.5		3.5	V	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	
Forward Transfer Admittance	yfs	4.0			S	VDS = 10 V, ID = 4.0 A	
Drain Leakage Current	Ipss			100	μΑ	V <sub>DS</sub> = V <sub>DSS</sub> , V <sub>GS</sub> = 0	
Gate to Source Leakage Current	Igss			±100	nA	Vgs = ±30 V,	V <sub>DS</sub> = 0
Input Capacitance	Ciss		1600		pF	V <sub>DS</sub> = 10 V	
Output Capacitance	Coss		310		pF	Vgs = 0	
Reverse Transfer Capacitance	Crss		30		pF	f = 1 MHz	
Turn-On Delay Time	td (on)		20		ns	ID = 4.0 A	
Rise Time	tr		13		ns	$V_{GS} = 10 V$	
Turn-Off Delay Time	td (off)		83		ns	V <sub>DD</sub> = 150 V	
Fall Time	tf		16		ns	R <sub>G</sub> = 10 Ω R	$L = 37.5 \Omega$
Total Gate Charge	Qg		42		nC	ID = 8 A	
Gate to Source Charge	Qgs		10		nC	V <sub>DD</sub> = 400 V	
Gate to Drain Charge	QgD		20		nC	V <sub>G</sub> S = 10 V	
Body Diode Forward Voltage	VF (S-D)		1.0		V	IF = 8 A, VGS	= 0
Reverse Recovery Time	trr		350		ns	IF = 8 A, VGS	= 0
Reverse Recovery Charge	Qrr		1.5		μC	di/dt = 50 A/	μs

### **Test Circuit 1 Avalanche Capability**

# Test Circuit 2 Switching Time

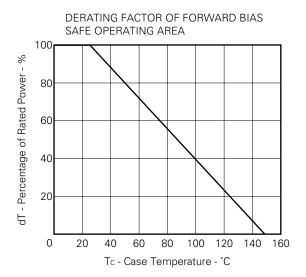


## **Test Circuit 3 Gate Charge**

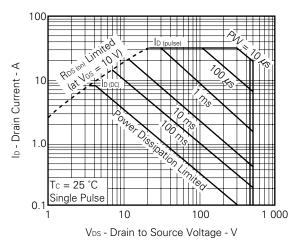


The application circuits and their parameters are for references only and are not intended for use in actual design-in's.

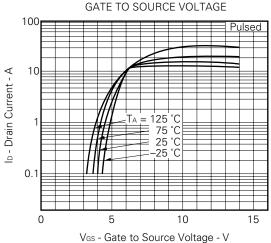
#### TYPICAL CHARACTERISTICS (TA = 25 °C)

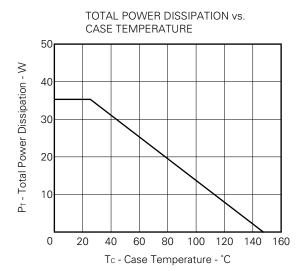


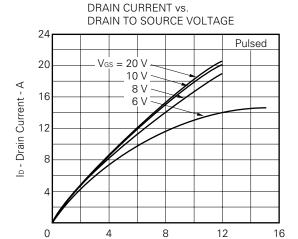




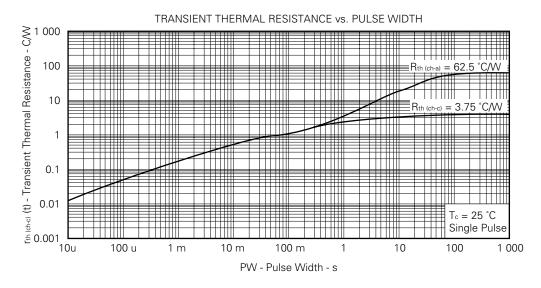
DRAIN CURRENT vs.
GATE TO SOURCE VOLTAGE



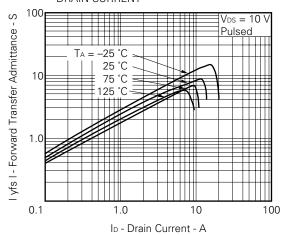




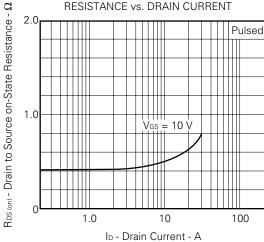
V<sub>DS</sub> - Drain to Source Voltage - V



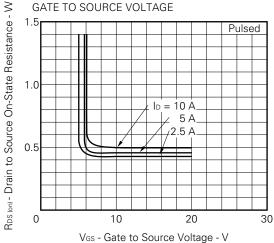
FORWARD TRANSFER ADMITTANCE vs. **DRAIN CURRENT** 



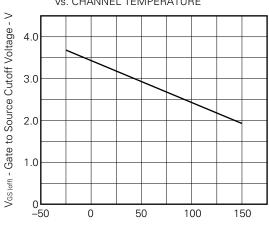
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



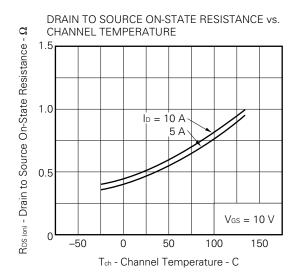
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

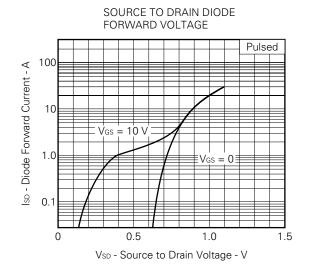


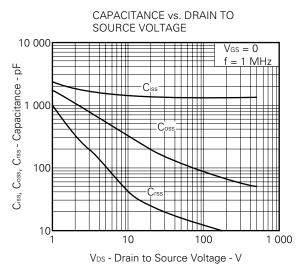
GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE

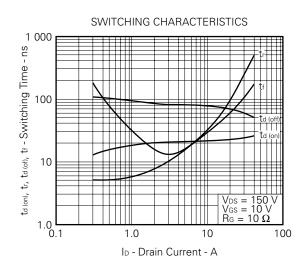


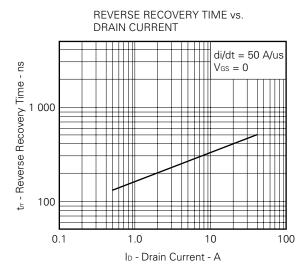
Tch - Channel Temperature - C

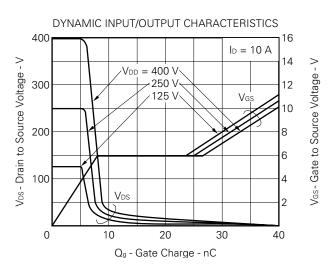








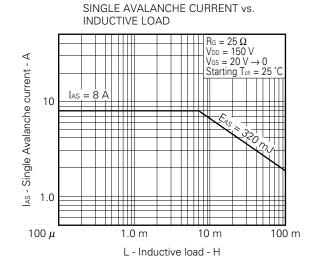






# SINGLE AVALANCHE ENERGY vs. STARTING CHANNEL TEMPERATURE 400 $|D| (peak) = |AS| RG = 25 \Omega$ $|V| (SS) = 20 V \rightarrow 0 V$ |V| (DD) = 150 V

Starting Tch-Starting Channel Temperature - °C



### **REFERENCE**

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	TEI-1202
Quality grade on NEC semiconductor devices.	IEI-1209
Semiconductor device mounting technology manual.	IEI-1207
Semiconductor device package manual.	IEI-1213
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	MF-1134
Power MOS FET features and application switching power supply.	TEA-1034
Application circuits using Power MOS FET.	TEA-1035
Safe operating area of Power MOS FET.	TEA-1037

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device is actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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